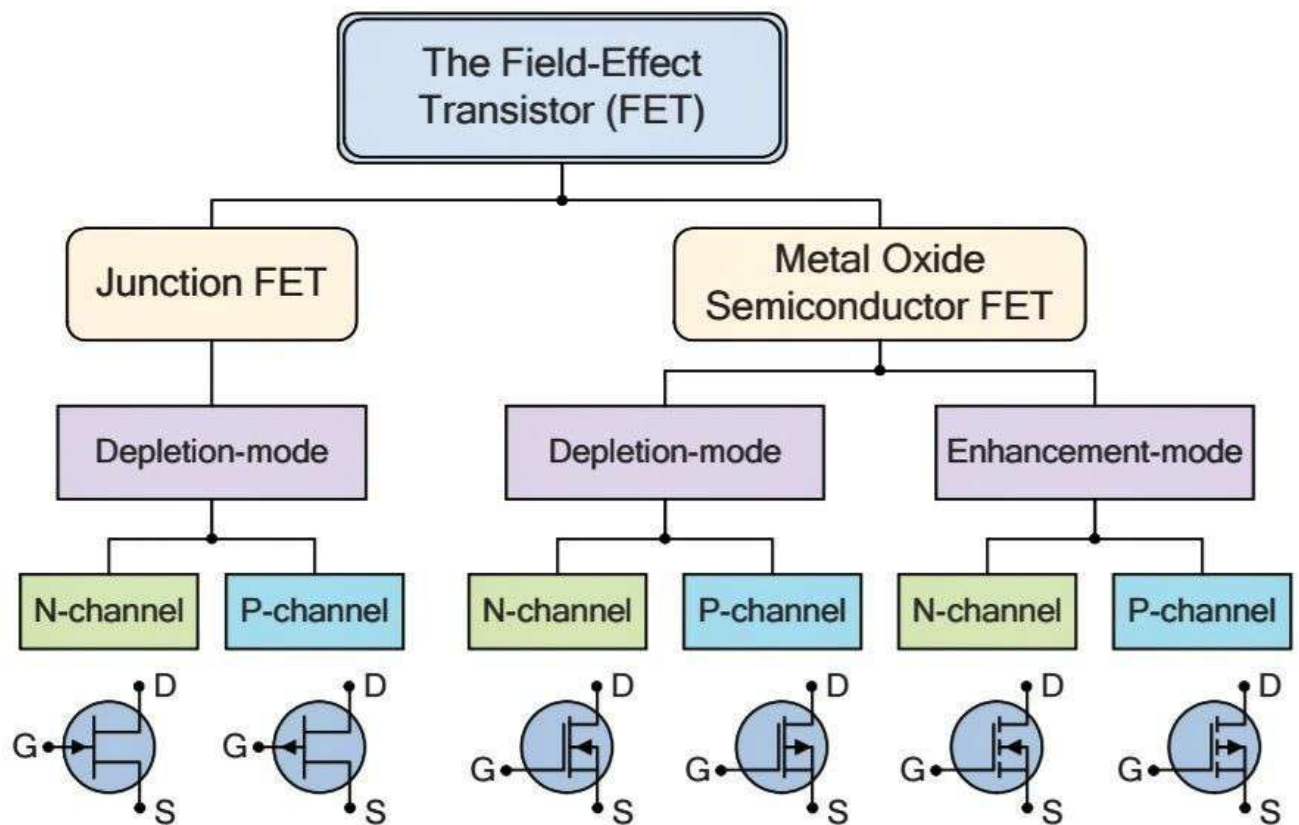


FET TYPES



Slide 1

FET

FET's (Field – Effect Transistors) are much like BJT's (Bipolar Junction Transistors).

Similarities:

- Amplifiers
- Switching devices
- Impedance matching circuits

Differences:

- FET's are voltage controlled devices whereas BJT's are current controlled devices.
- FET's also have a higher input impedance, but BJT's have higher gains.
- FET's are less sensitive to temperature variations and because of there construction they are more easily integrated on IC's.
- FET's are also generally more static sensitive than BJT's.

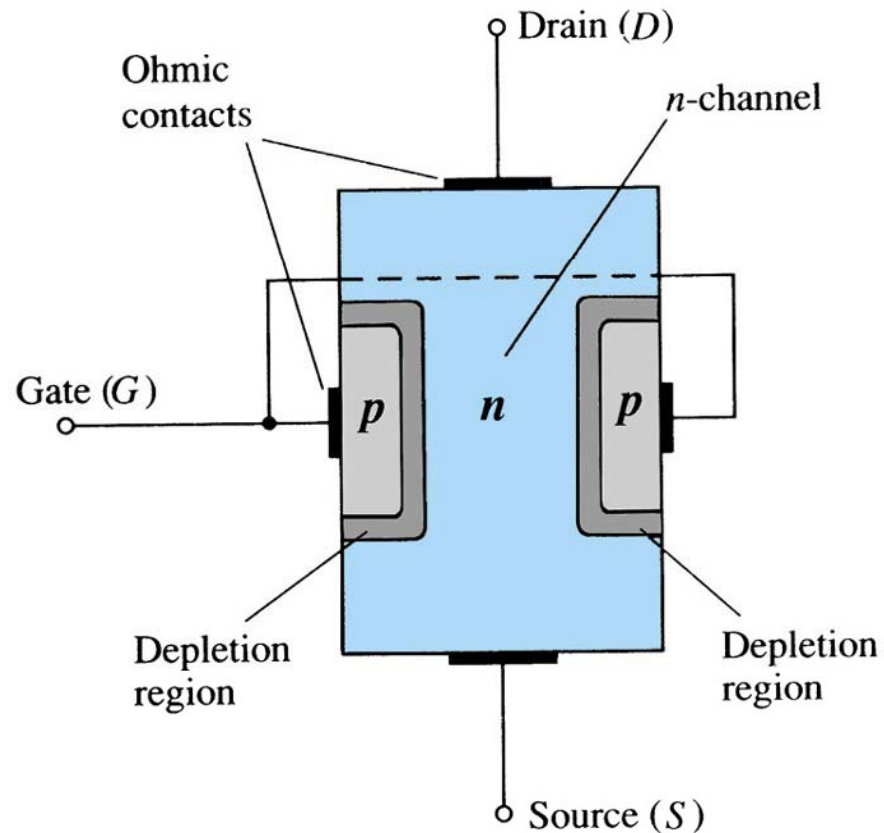
FET Types

- **JFET** ~ Junction Field-Effect Transistor
- **MOSFET** ~ Metal-Oxide Field-Effect Transistor
 - **D-MOSFET** ~ Depletion MOSFET
 - **E-MOSFET** ~ Enhancement MOSFET

Slide 3

JFET Construction

There are two types of JFET's: n-channel and p-channel.
The n-channel is more widely used.

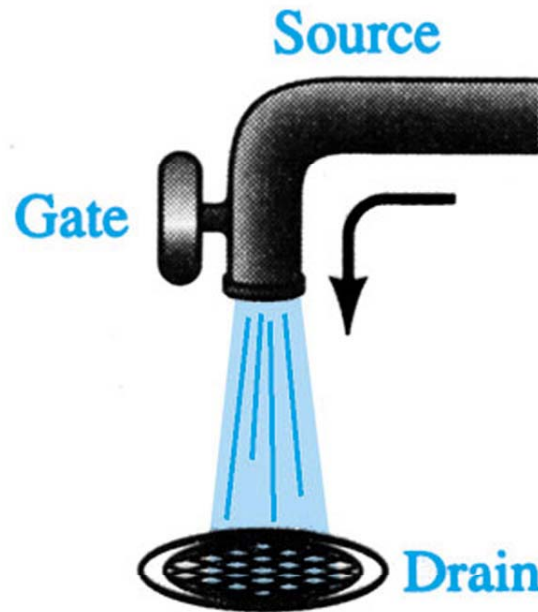


There are three terminals: Drain (D) and Source (S) are connected to n-channel
Gate (G) is connected to the p-type material

Slide 4

Basic Operation of JFET

JFET operation can be compared to a water spigot:



The source of water pressure – accumulated electrons at the negative pole of the applied voltage from Drain to Source

The drain of water – electron deficiency (or holes) at the positive pole of the applied voltage from Drain to Source.

The control of flow of water – Gate voltage that controls the width of the n-channel, which in turn controls the flow of electrons in the n-channel from source to drain.

Slide 5

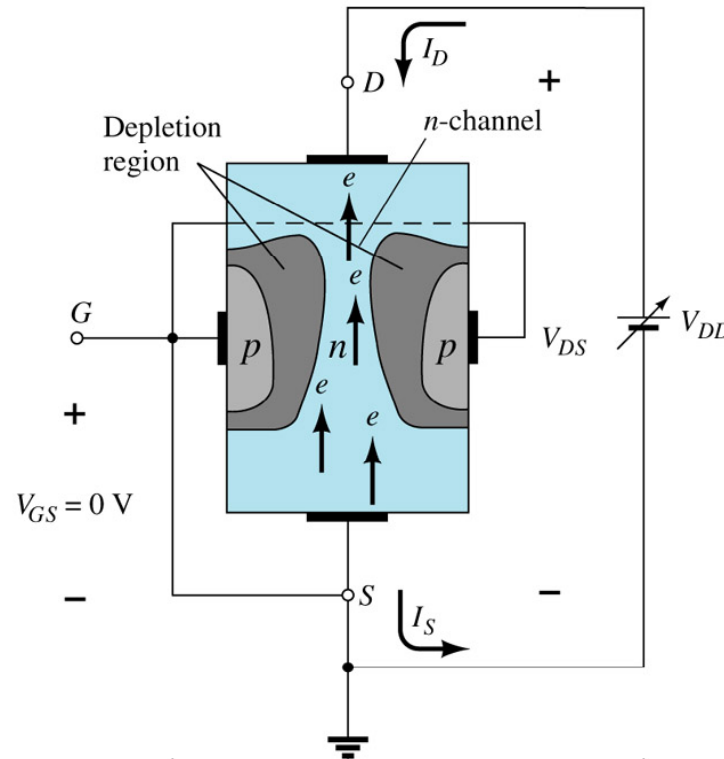
JFET Operating Characteristics

There are three basic operating conditions for a JFET:

- A. $V_{GS} = 0$, V_{DS} increasing to some positive value
- B. $V_{GS} < 0$, V_{DS} at some positive value
- C. Voltage-Controlled Resistor

Slide 6

A. $V_{GS} = 0$, V_{DS} increasing to some positive value

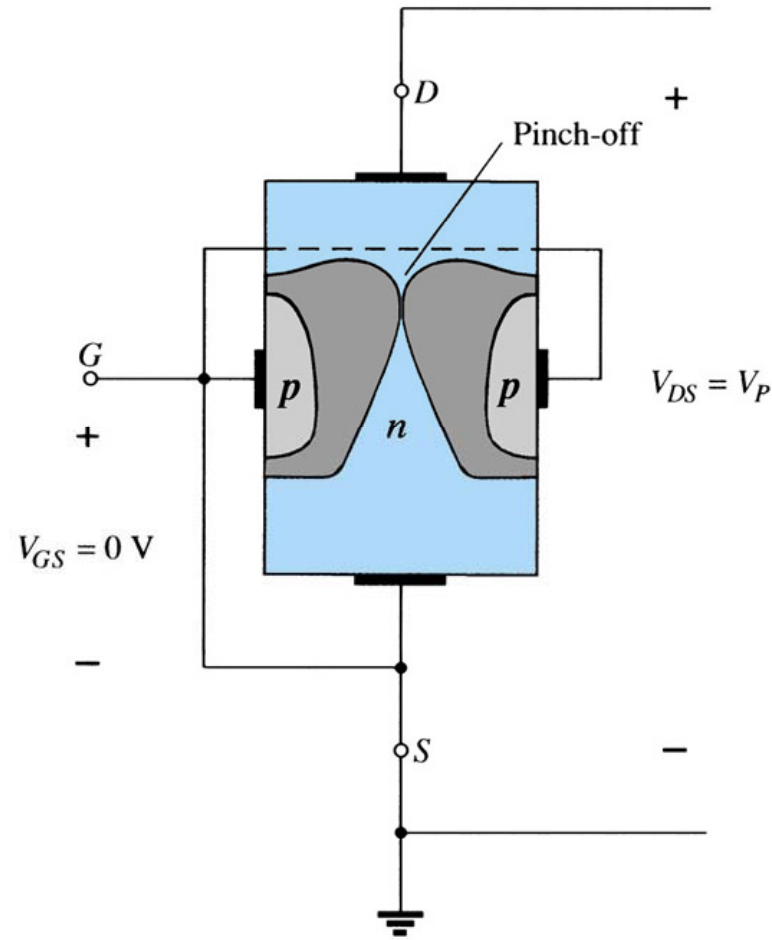


Three things happen when $V_{GS} = 0$ and V_{DS} is increased from 0 to a more positive voltage:

- the depletion region between p-gate and n-channel increases as electrons from n-channel combine with holes from p-gate.
- increasing the depletion region, decreases the size of the n-channel which increases the resistance of the n-channel.
- But even though the n-channel resistance is increasing, the current (I_D) from Source to Drain through the n-channel is increasing. This is because V_{DS} is increasing.

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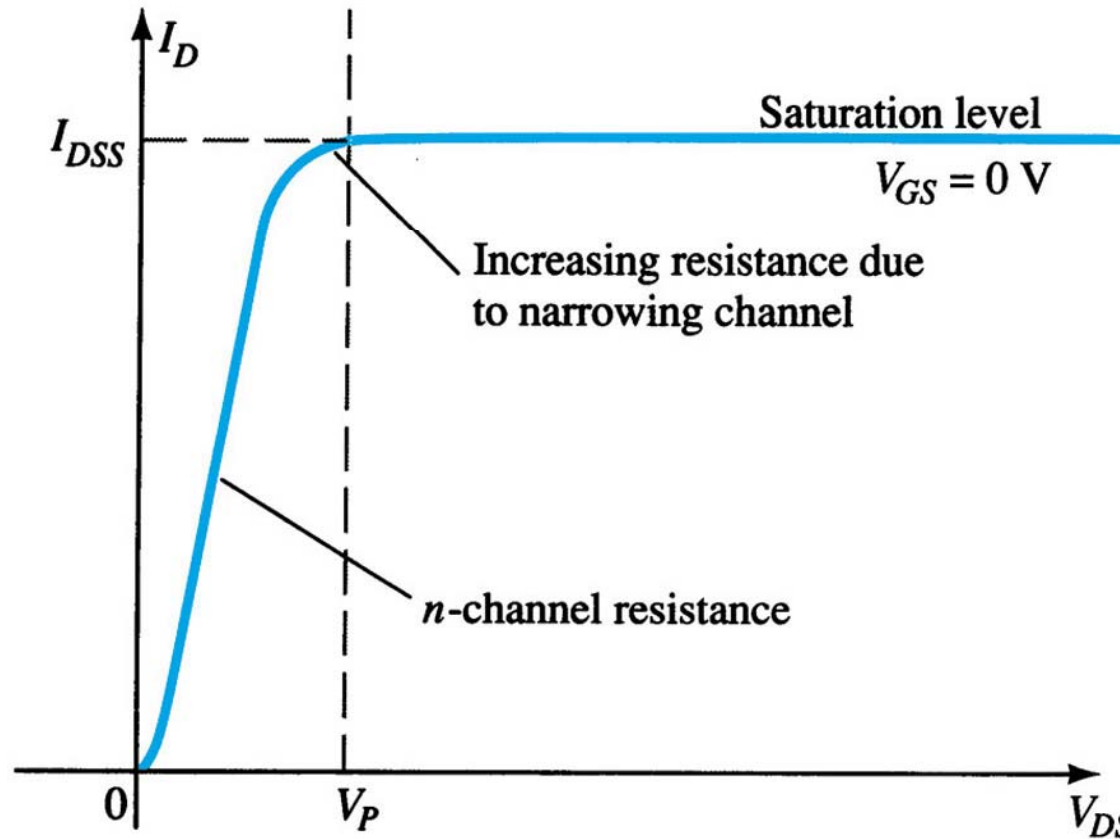
Pinch-off



If $V_{GS} = 0$ and V_{DS} is further increased to a more positive voltage, then the depletion zone gets so large that it **pinches off** the n-channel. This suggests that the current in the n-channel (I_D) would drop to 0A, but it does just the opposite: as V_{DS} increases, so does I_D .

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Saturation

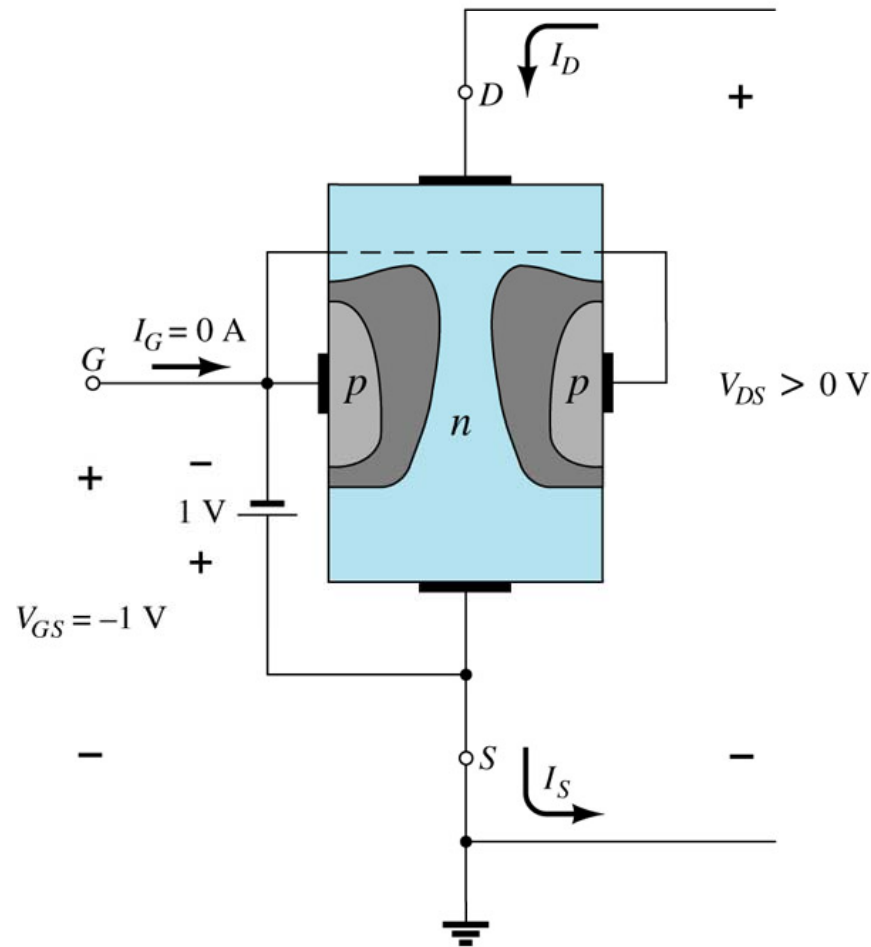


At the pinch-off point:

- any further increase in V_{GS} does not produce any increase in I_D . V_{GS} at pinch-off is denoted as V_p .
- I_D is at saturation or maximum. It is referred to as I_{DSS} .
- The ohmic value of the channel is at maximum.

Slide 9

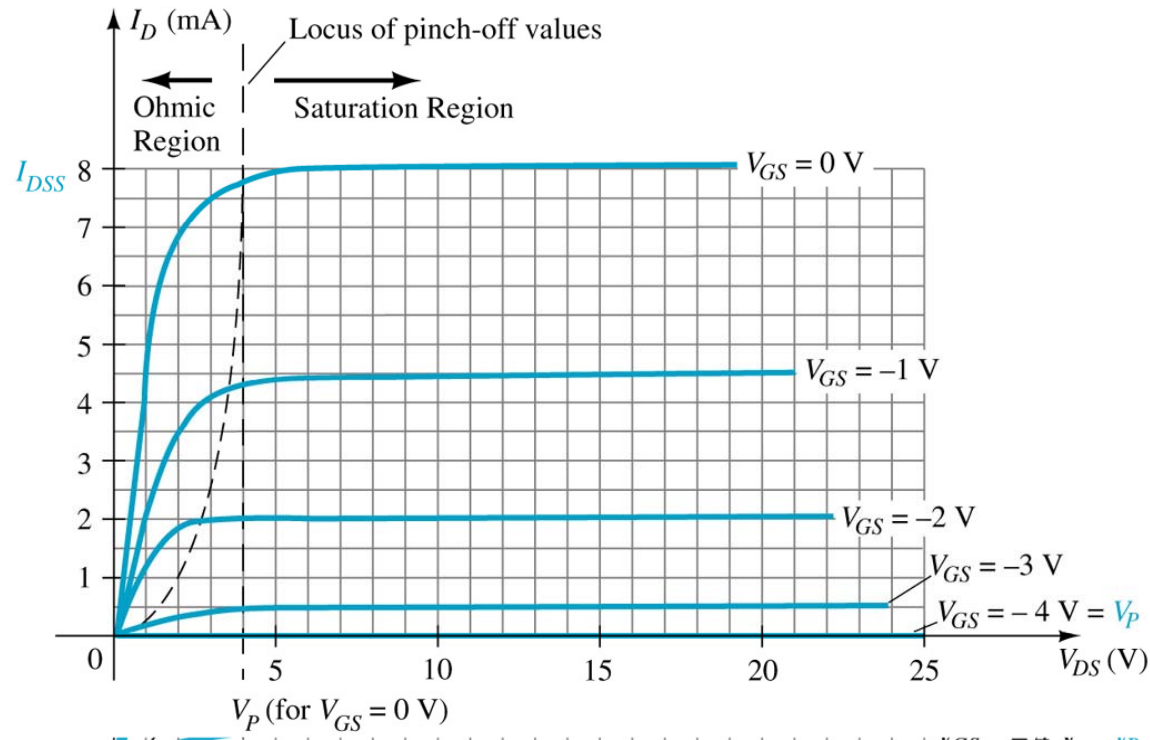
B. $V_{GS} < 0$, V_{DS} at some positive value



As V_{GS} becomes more negative the depletion region increases.

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$$I_D < I_{DSS}$$

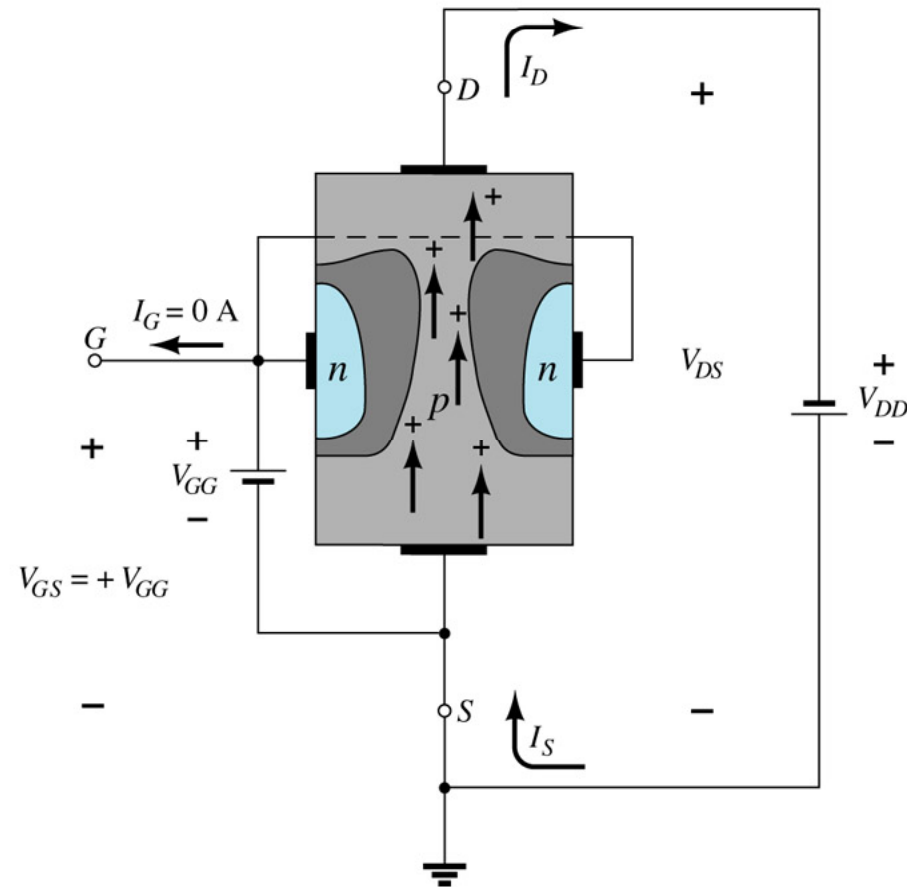


As V_{GS} becomes more negative:

- the JFET will pinch-off at a lower voltage (V_P).
- I_D decreases ($I_D < I_{DSS}$) even though V_{DS} is increased.
- Eventually I_D will reach 0A. V_{GS} at this point is called V_P or $V_{GS(off)}$.
- Also note that at high levels of V_{DS} the JFET reaches a breakdown situation. I_D will increase uncontrollably if $V_{DS} > V_{DSmax}$.

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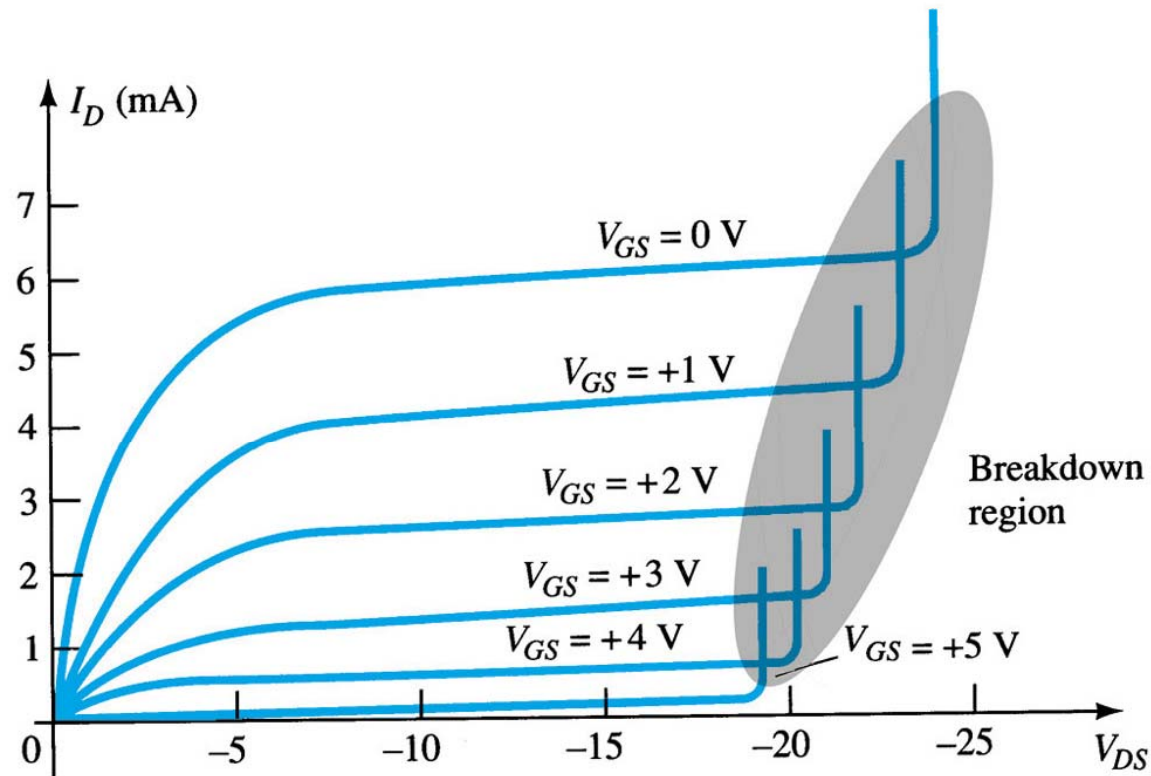
p-Channel JFETs



p-Channel JFET acts the same as the n-channel JFET, except the polarities and currents are reversed.

Slide 13

P-Channel JFET Characteristics



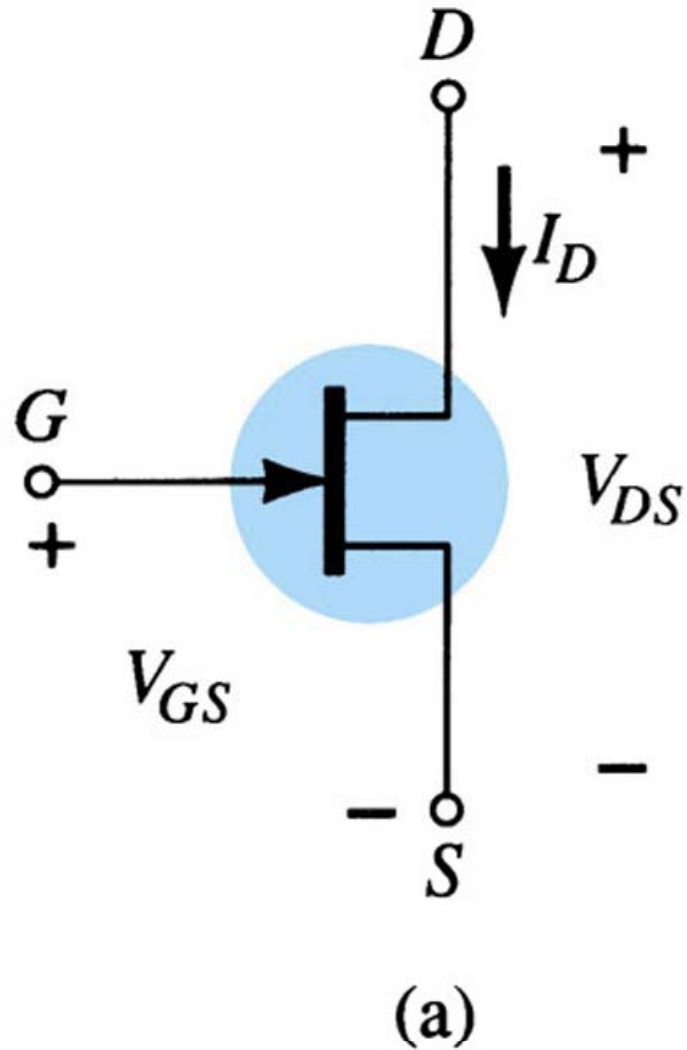
As V_{GS} increases more positively:

- the depletion zone increases
- I_D decreases ($I_D < I_{DSS}$)
- eventually $I_D = 0\text{ A}$

Also note that at high levels of V_{DS} the JFET reaches a breakdown situation. I_D increases uncontrollably if $V_{DS} > V_{DSmax}$.

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JFET Symbols



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MOSFETs

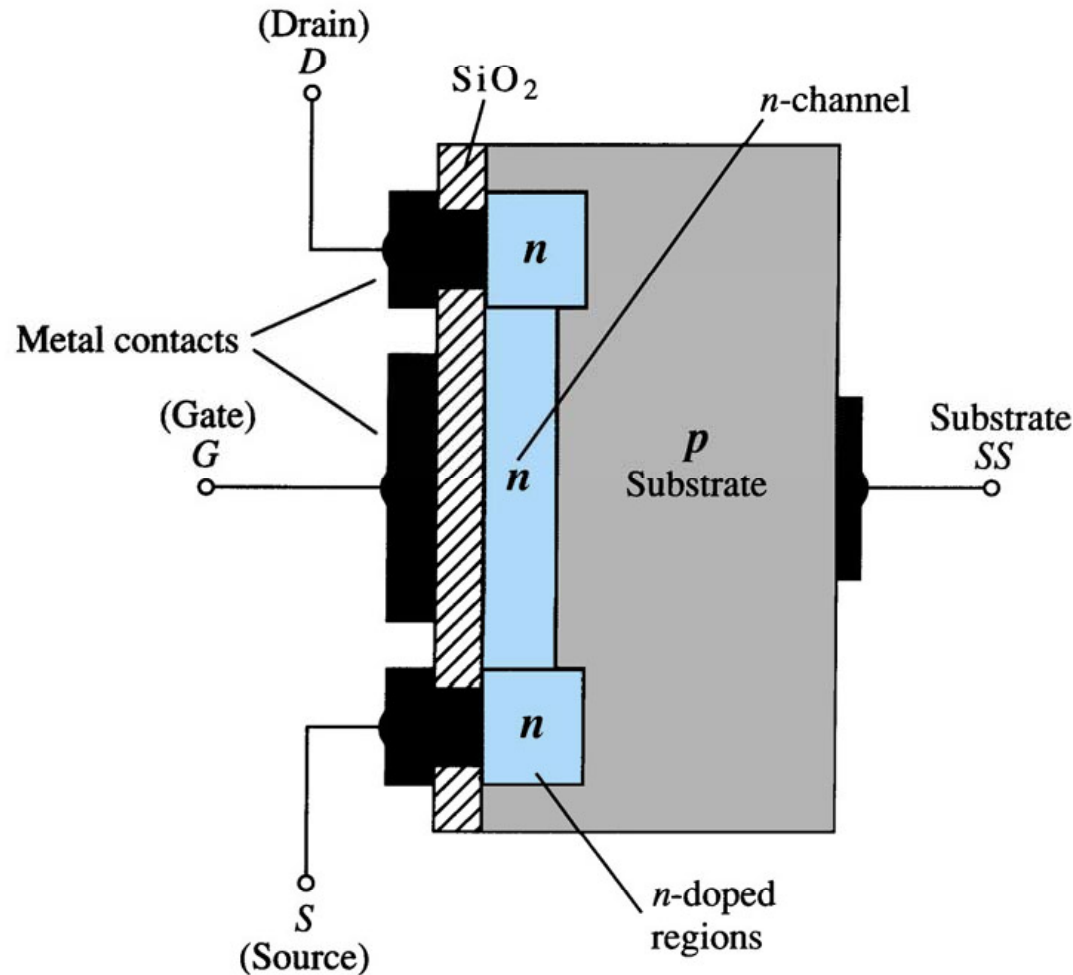
MOSFETs have characteristics similar to JFETs and additional characteristics that make them very useful.

There are 2 types:

- Depletion-Type MOSFET
- Enhancement-Type MOSFET

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Depletion-Type MOSFET Construction

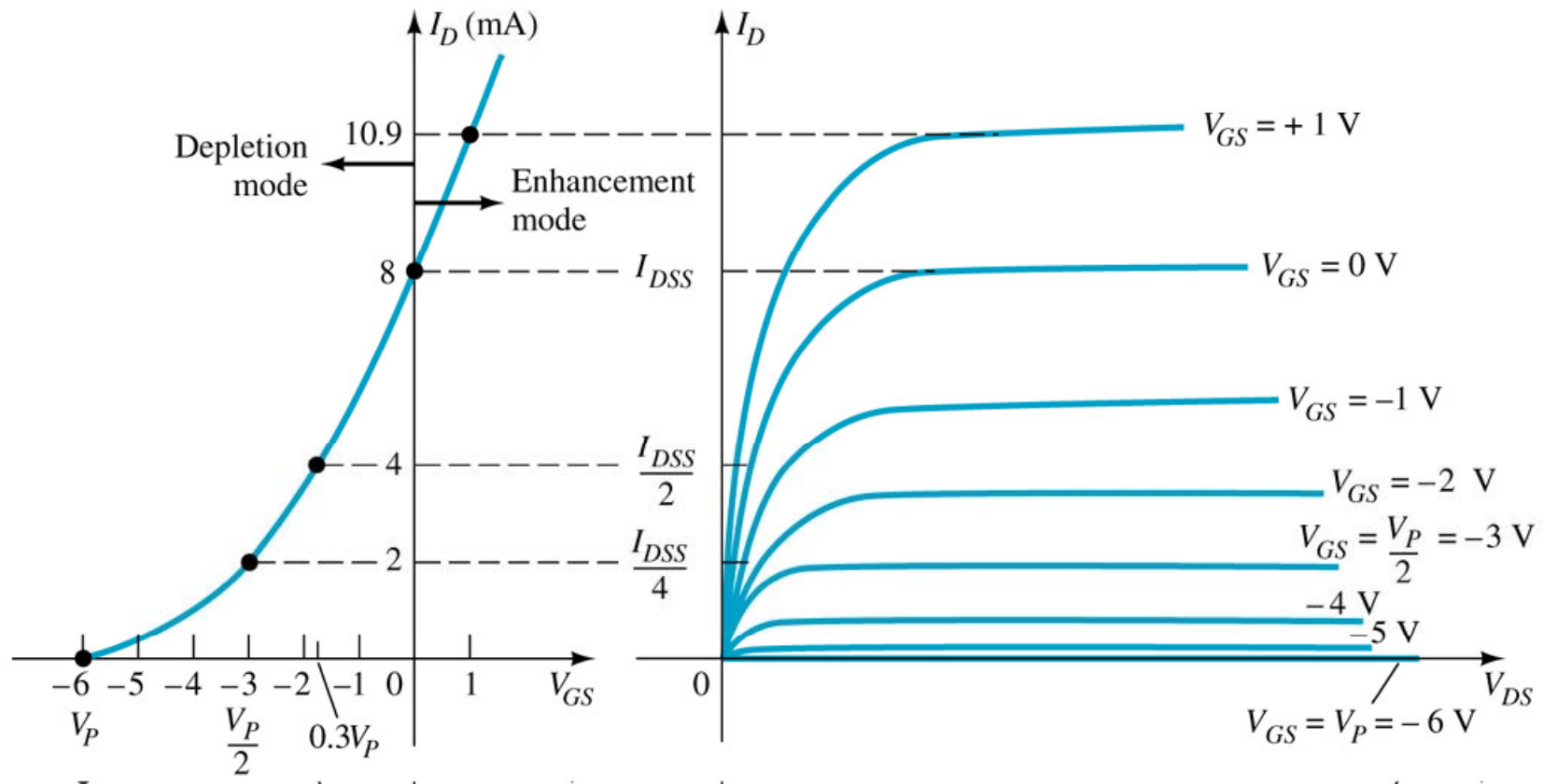


The Drain (D) and Source (S) connect to the n -doped regions. These N -doped regions are connected via an n -channel. This n -channel is connected to the Gate (G) via a thin insulating layer of SiO_2 . The n -doped material lies on a p -doped substrate that may have an additional terminal connection called SS.

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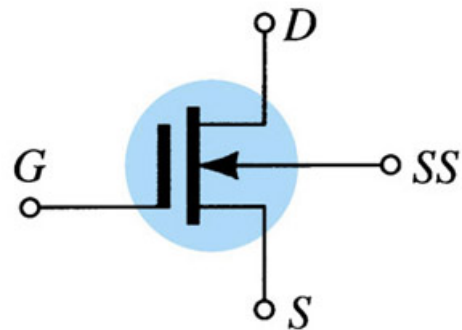
Basic Operation

A Depletion MOSFET can operate in two modes: Depletion or Enhancement mode.

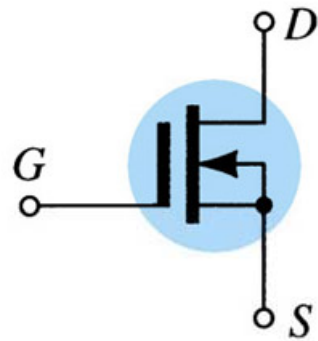
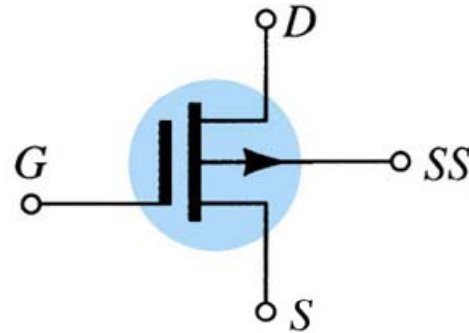


Symbols

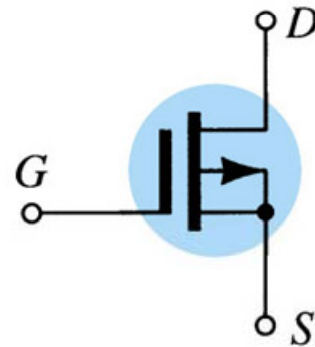
n -channel



p -channel



(a)



(b)

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Specification Sheet

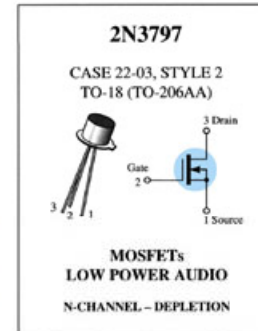
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	Vdc
Gate-Source Voltage	V_{GS}	± 10	Vdc
Drain Current	I_D	20	mA dc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	200 1.14	mW mW/°C
Junction Temperature Range	T_J	+175	°C
Storage Channel Temperature Range	T_{stg}	-65 to +200	°C

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

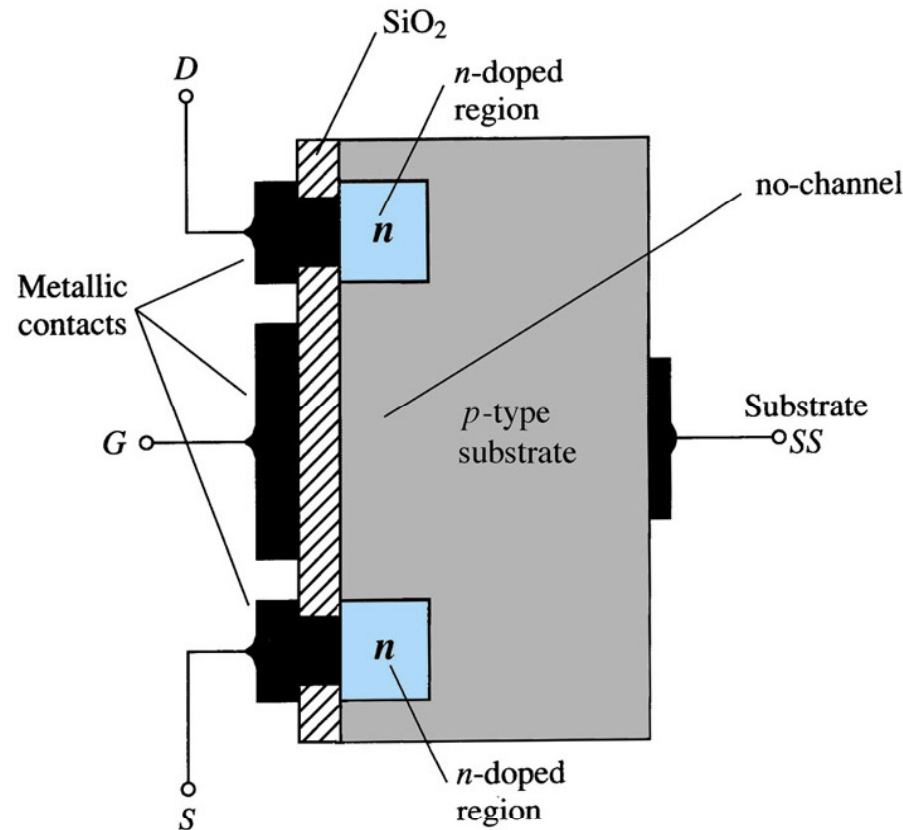
Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Drain-Source Breakdown Voltage ($V_{GS} = -7.0\text{ V}$, $I_D = 5.0\text{ }\mu\text{A}$)	$V_{BR(DSS)}$	20	25	—	Vdc
Gate Reverse Current (1) ($V_{DS} = -10\text{ V}$, $V_{GS} = 0$) ($V_{GS} = -10\text{ V}$, $V_{DS} = 0$, $T_A = 150^\circ\text{C}$)	I_{GSS}	—	—	1.0 200	pA dc
Gate-Source Cutoff Voltage ($I_D = 2.0\text{ }\mu\text{A}$, $V_{DS} = 10\text{ V}$)	$V_{GS(off)}$	—	-5.0	-7.0	Vdc
Drain-Gate Reverse Current (1) ($V_{DS} = 10\text{ V}$, $I_S = 0$)	I_{DGO}	—	—	1.0	pA dc
ON CHARACTERISTICS					
Zero-Gate-Voltage Drain Current ($V_{DS} = 10\text{ V}$, $V_{GS} = 0$)	I_{DSS}	2.0	2.0	6.0	mA dc
On-State Drain Current ($V_{DS} = 10\text{ V}$, $V_{GS} = +3.5\text{ V}$)	$I_{D(on)}$	9.0	14	18	mA dc
SMALL-SIGNAL CHARACTERISTICS					
Forward Transfer Admittance ($V_{DS} = 10\text{ V}$, $V_{GS} = 0$, $f = 1.0\text{ kHz}$)	$ y_{fs} $	1500	2300	3000	μmhos
($V_{DS} = 10\text{ V}$, $V_{GS} = 0$, $f = 1.0\text{ MHz}$)		1500	—	—	
Output Admittance ($I_{DS} = 10\text{ V}$, $V_{GS} = 0$, $f = 1.0\text{ kHz}$)	$ y_{os} $	—	27	60	μmhos
Input Capacitance ($V_{DS} = 10\text{ V}$, $V_{GS} = 0$, $f = 1.0\text{ MHz}$)	C_{iss}	—	6.0	8.0	pF
Reverse Transfer Capacitance ($V_{DS} = 10\text{ V}$, $V_{GS} = 0$, $f = 1.0\text{ MHz}$)	C_{rss}	—	0.5	0.8	pF
FUNCTIONAL CHARACTERISTICS					
Noise Figure ($V_{DS} = 10\text{ V}$, $V_{GS} = 0$, $f = 1.0\text{ kHz}$, $R_L = 3\text{ megohms}$)	NF	—	3.8	—	dB

(1) This value of current includes both the FET leakage current as well as the leakage current associated with the test socket and fixture when measured under best attainable conditions.



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Enhancement-Type MOSFET Construction

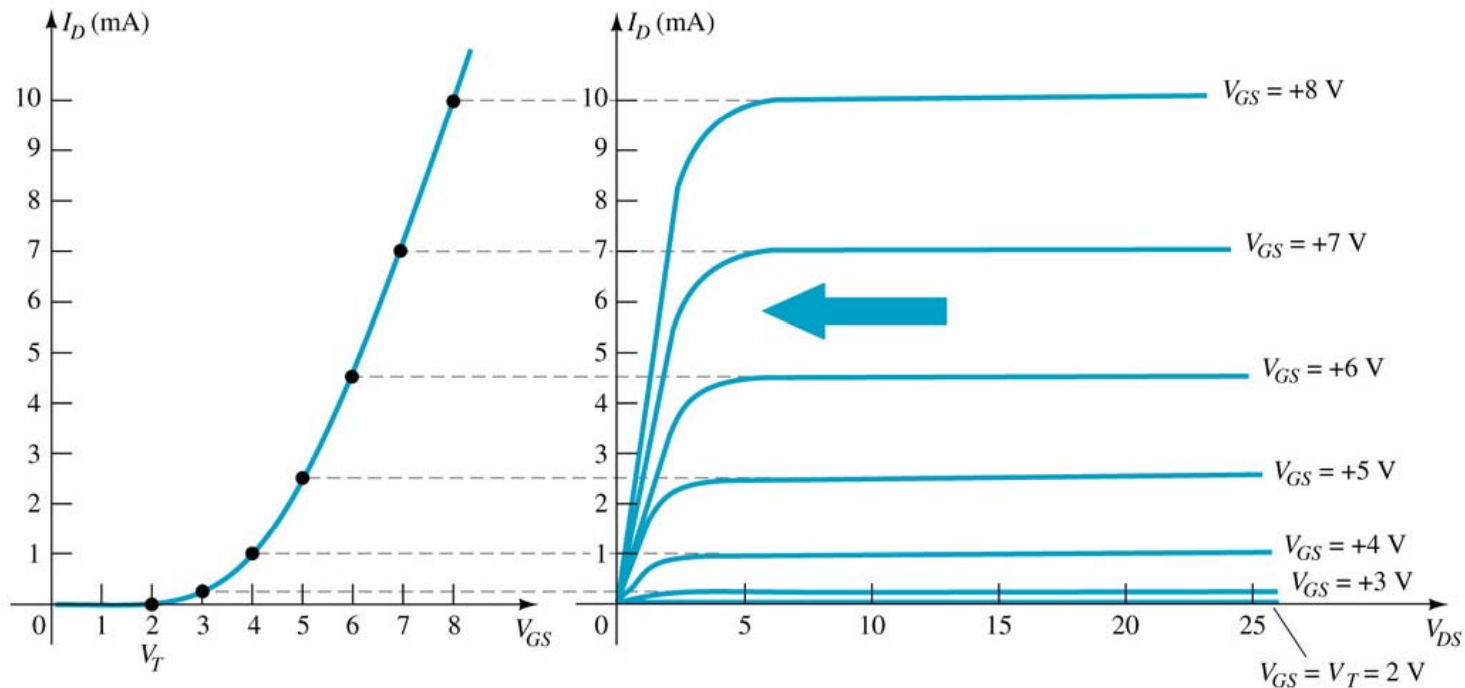


The Drain (D) and Source (S) connect to the *n*-doped regions. These *n*-doped regions are connected via an *n*-channel. The Gate (G) connects to the *p*-doped substrate via a thin insulating layer of SiO_2 . There is no channel. The *n*-doped material lies on a *p*-doped substrate that may have an additional terminal connection called SS.

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Basic Operation

The Enhancement-type MOSFET only operates in the enhancement mode.



V_{GS} is always positive

As V_{GS} increases, I_D increases

But if V_{GS} is kept constant and V_{DS} is increased, then I_D saturates (I_{DSS})

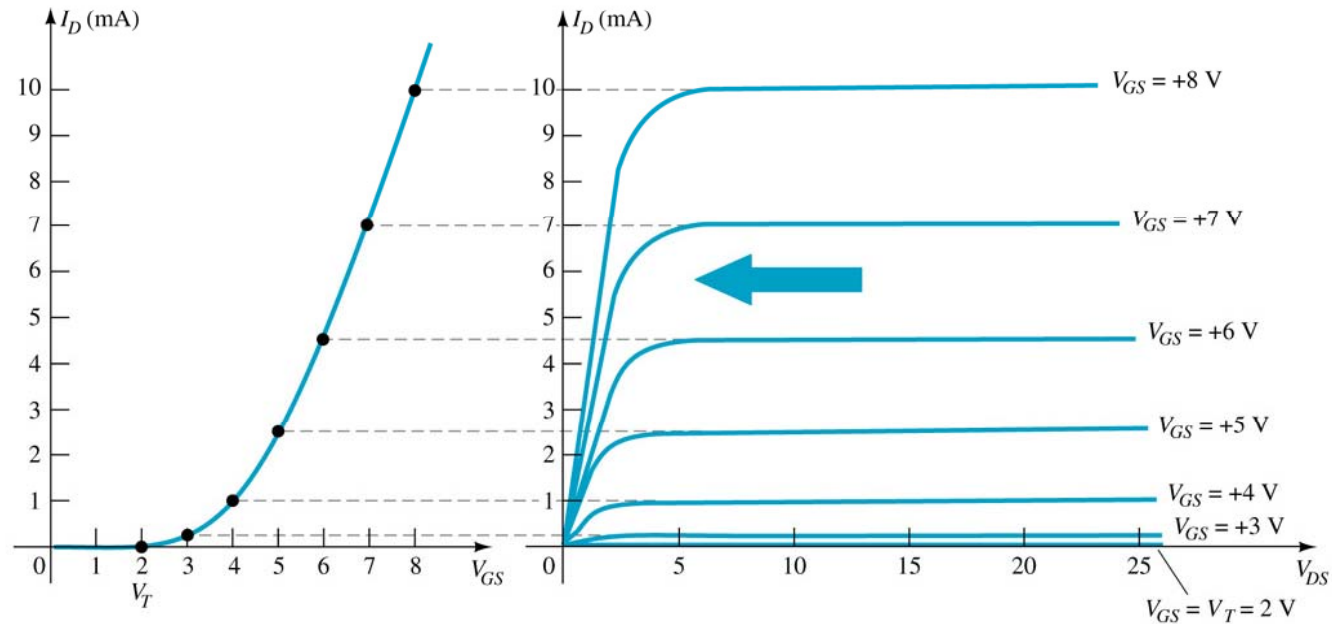
The saturation level, V_{DSsat} is reached.

$$V_{Dsat} = V_{GS} - V_T$$

[Formula 5.12]

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Transfer Curve



To determine I_D given V_{GS} :

$$I_D = k(V_{GS} - V_T)^2$$

[Formula 5.13]

where V_T = threshold voltage or voltage at which the MOSFET turns on.

k = constant found in the specification sheet

k can also be determined by using values at a specific point and the formula:

$$k = \frac{I_{D(on)}}{(V_{GS(on)} - V_T)^2}$$

[Formula 5.14]

V_{DSsat} can also be calculated:

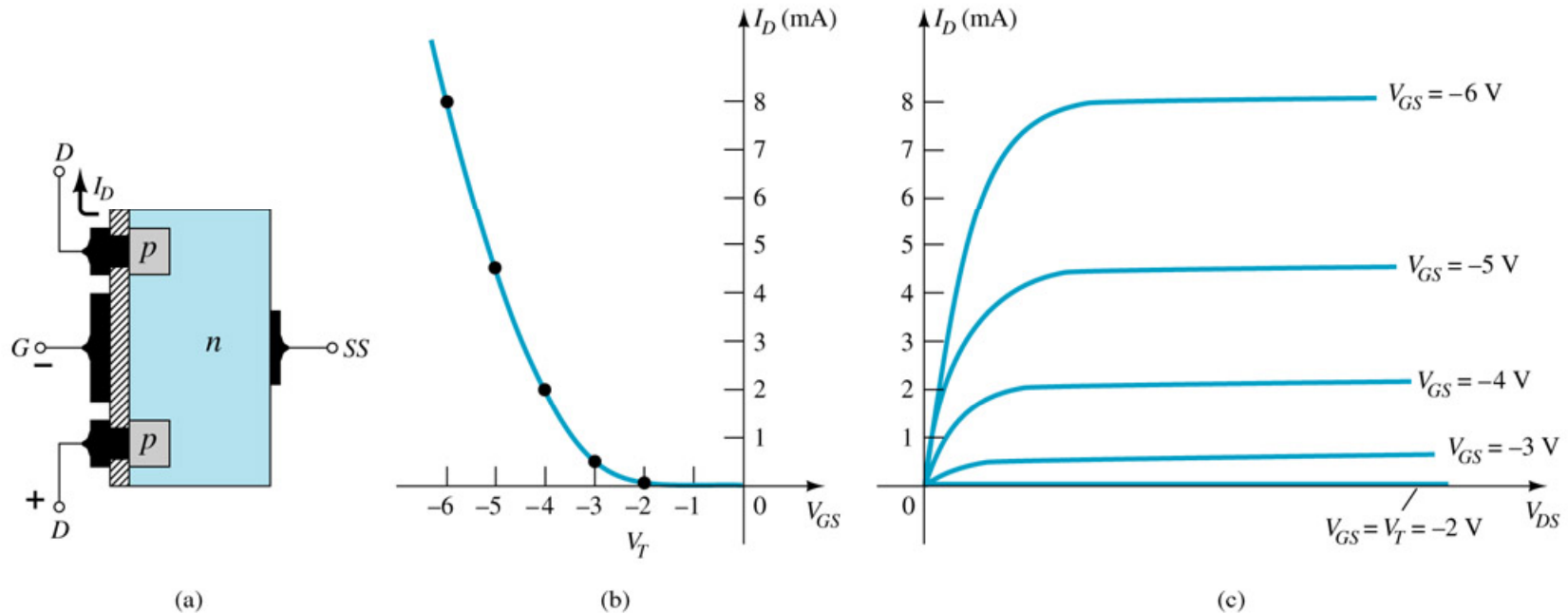
$$V_{Dsat} = V_{GS} - V_T$$

[Formula 5.12]

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p-Channel Enhancement-Type MOSFETs

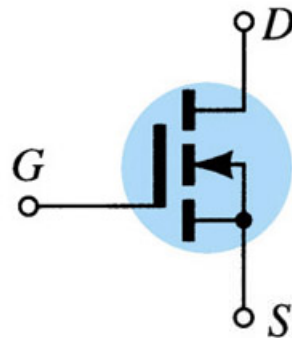
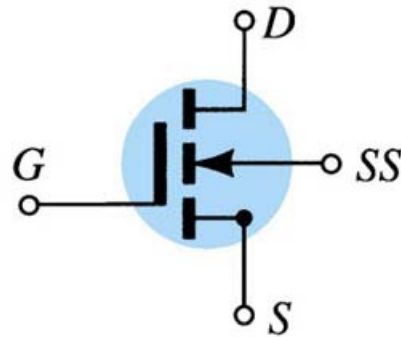
The p-channel Enhancement-type MOSFET is similar to the n-channel except that the voltage polarities and current directions are reversed.



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Symbols

n-channel



(a)